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Renesas Electronics Corporation

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H8/300L SLP Series

Transition to High-Speed Sleep Mode

Introduction

An IRQ0 interrupt is generated during program execution in the active mode, and the system enters a sleep mode (high speed) by executing a SLEEP instruction after the IRQ0 interrupt handling is completed.

Target Device

H8/38024

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1. Specifications

1. This sample task shows an example of making transition to the high-speed sleep mode.
2. An IRQ0 interrupt is generated by the input from a switch on the $\overline{\text{IRQ0}}$ pin during program execution in the active mode. The system enters a sleep mode (high speed) by executing a SLEEP instruction after the IRQ0 interrupt handling is completed.
3. A Timer A interrupt is generated one second after the transition to the sleep mode. This causes the system to leave the sleep mode and return to the high-speed active mode.
4. The LED is turned when the program is started, and turned off when the system enters the sleep mode. The LED is turned on again upon transition to the active mode.
5. The LED is connected to the P92 output pin of port 9.
6. P92 is a large-current port.
7. Figure 1.1 shows an example of connecting a switch to the $\overline{\text{IRQ0}}$ pin.

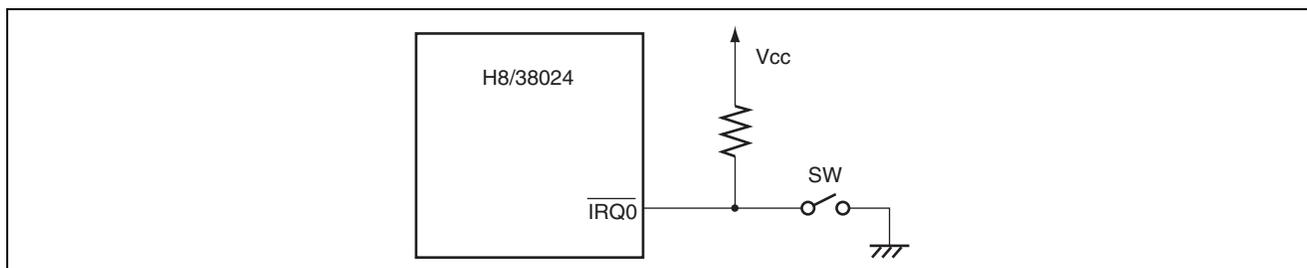


Figure 1.1 Example of Switch Connection for Transition to High-Speed Sleep Mode

2. Description of Functions

1. In this sample task, transition to the high-speed sleep mode, a power down mode, is made. Figure 2.1 shows a mode transition diagram to the high-speed sleep mode. The function of the high-speed sleep mode is described below.
 - When a SLEEP instruction is executed in the active mode while SSBY and LSON in SYSCR1 are both set to 0, and MSON and DTON in SYSCR2 are both set to 0, the system enters the high-speed sleep mode.
 - During a sleep mode, the CPU operation is halted but on-chip peripheral modules operate.
 - Sleep modes can be terminated by any interrupt (Timer A, Timer C, Timer F, Timer G, asynchronous event counter, IRQAEC, IRQ4, IRQ3, IRQ1, IRQ0, WKP7 to WKP0, SCI3 and A/D converter) or by RES pin input.
 - In the case of terminating the mode by an interrupt, the high-speed sleep mode is terminated upon generation of an interrupt and the interrupt exception handling starts. From the high-speed sleep mode, transition to the high-speed active mode is possible.
 - The high-speed sleep mode is not cleared if the I bit in CCR is set to 1 or acceptance of the interrupt is disabled by the interrupt enable register.
 - In the case of terminating the mode by the $\overline{\text{RES}}$ pin, when the $\overline{\text{RES}}$ pin is driven "Low", the system enters a reset state and the high-speed sleep mode thus ends.
 - In this sample task, the high-speed sleep mode is terminated by Timer A interrupt.

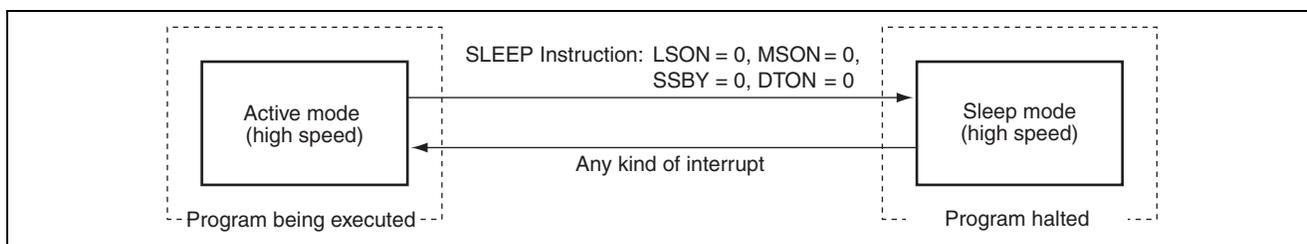


Figure 2.1 Mode Transition from/to High-Speed Sleep Mode

2. Table 2.1 shows the function assignments in this sample task. Transition to the high-speed sleep mode is carried out by assigning the functions as shown below.

Table 2.1 Assignment of Functions

Function	Assigned Function
PSW	A 5-bit up counter using the subclock (32.768 kHz)/4 as input.
SYSCR1	Controls power down modes.
SYSCR2	Controls power down modes.
TMA	Sets TCA overflow cycle to 1 sec.
TCA	1 sec. timer
PDR9	P92 output pin data storage
IEN0	Enables $\overline{\text{IRQ0}}$ pin interrupt requests.
IEG0	Selects $\overline{\text{IRQ0}}$ pin input edge.
IENTA	Enables Timer A interrupt requests.
IRRTA	Indicates whether or not a Timer A interrupt request has been generated.
IRRI0	Indicates whether or not an $\overline{\text{IRQ0}}$ interrupt request has been generated.
P92	LED output
$\overline{\text{IRQ0}}$	Switch input

3. Principle of Operation

1. Figure 3.1 illustrates the operation of this sample task. Transition to the high-speed sleep mode is carried out through hardware and software processing as shown in the figure.

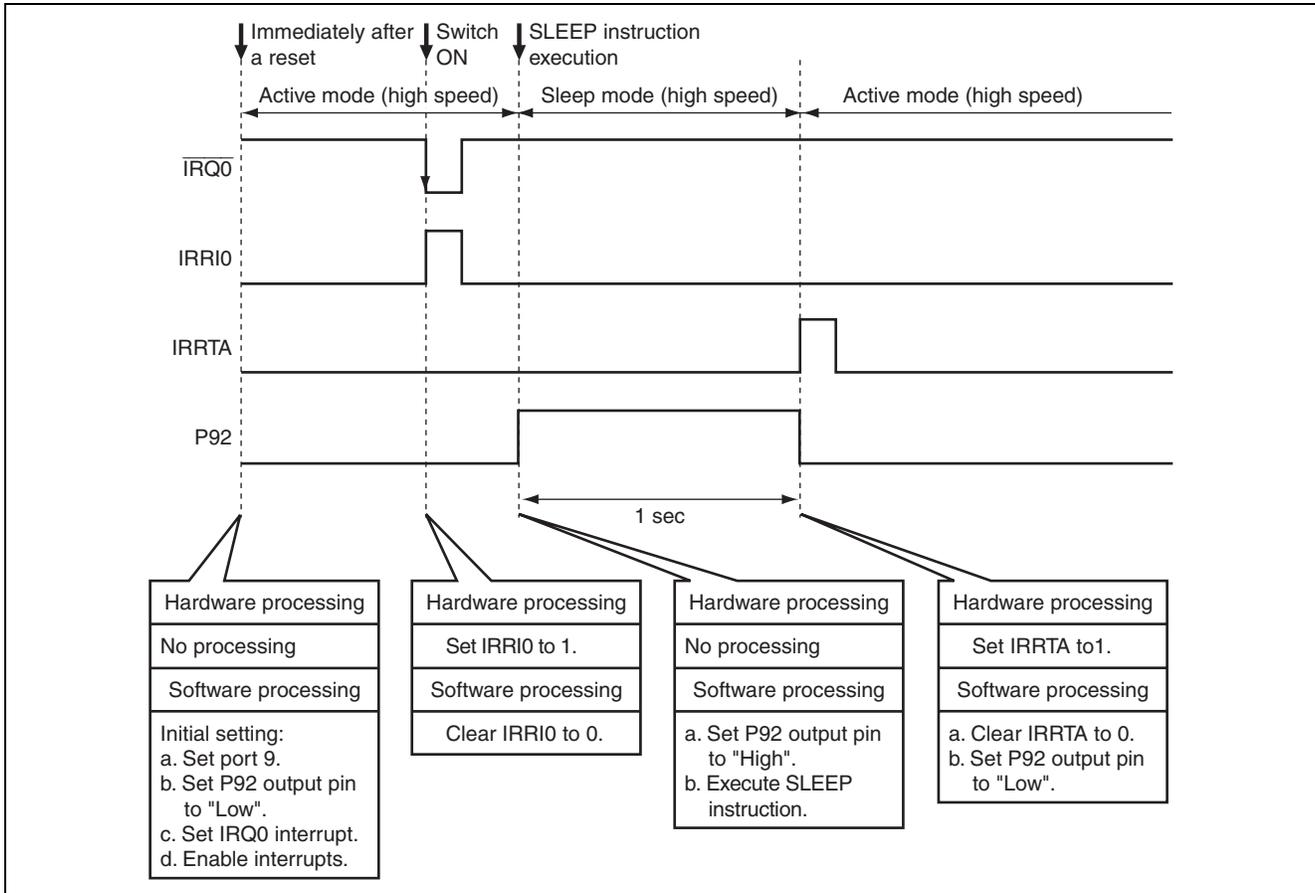


Figure 3.1 Operation Principle of Making Transition to High-Speed Sleep Mode

4. Description of Software

4.1 Modules

The modules used in this sample task are shown in table 4.1.

Table 4.1 Description of Modules

Module	Label	Function
Main routine	main	Makes settings for IRQ0 interrupt, port 9, and Timer A interrupt, enables interrupts, controls the LED, and makes transition to the high-speed sleep mode.
Switch ON	Irq0int	An IRQ0 interrupt handling routine which sets SWONF and disables IRQ0 interrupts.
Terminate high-speed sleep mode	taint	A Timer A interrupt handling routine which disables Timer A interrupt.

4.2 Arguments

This sample task does not use arguments.

4.3 Internal Registers

Table 4.2 shows the internal registers involved in this sample task.

Table 4.2 Description of Internal Registers

Register	Function	Address	Setting
TMA	Timer Mode Register A If TMA = H'18, Timer A function is set to clock time-base function, TCA input clock source to PSW and TCA overflow cycle to 1 sec.	H'FFB0	H'18
TCA	Timer Counter A An 8-bit up-counter using clock input of 32.768 kHz / 32.	H'FFB1	H'00
PDR9 P92	Port Data Register 9 (Port Data Register 92) If P92 = 0, the output level on pin P92 is Low. If P92 = 1, the output level on pin P92 is High.	H'FFDC Bit 2	0
SYSCR1 SSBY	System Control Register 1 (Software Standby) If SSBY = 0, a transition is made to the sleep mode after a SLEEP instruction is executed in the active mode. A transition is made to the subsleep mode after a SLEEP instruction is executed in the subactive mode.	H'FFF0 Bit 7	0
LSON	System Control Register 1 (Low speed ON flag) If LSON = 0, the CPU operating clock is set to the system clock when the watch mode is terminated.	H'FFF0 Bit 3	0

Register	Function	Address	Setting	
SYSCR2	DTON	System Control Register 2 (Direct Transition ON Flag) If DTON = 0, a transition is made to the standby, watch or sleep mode when a SLEEP instruction is executed in the active mode. If DTON = 1, A direct transition is made to the high-speed active mode (when SSBY = 0, MSON = 0, LSON = 0) or to the subactive mode (when SSBY = 1, MSON = 1, LSON = 1) when a SLEEP instruction is executed in the high-speed active mode.	H'FFF1 Bit 3	0
	MSON	System Control Register 2 (Medium Speed ON Flag) If MSON = 0, the system operates in the high-speed active mode after the standby, watch or sleep mode is terminated. The system operates in the high-speed sleep mode if a SLEEP instruction is executed in the active mode. If MSON = 1, the system operates in the high-speed active mode after the standby, watch or sleep mode is terminated. The system operates in the medium-speed sleep mode if a SLEEP instruction is executed in the active mode.	H'FFF1 Bit 2	0
IEGR	IEG0	IRQ Edge Select Register (IRQ0 Edge Select) If IEG0 = 0, falling edge is selected for edge detection of $\overline{\text{IRQ0}}$ pin input. If IEG0 = 1, rising edge is selected for edge detection of $\overline{\text{IRQ0}}$ pin input.	H'FFF2 Bit 0	0
IENR1	IENTA	Interrupt Enable Register 1 (Timer A Interrupt Enable) If IENTA = 0, Timer A interrupt requests are disabled. If IENTA = 1, Timer A interrupt requests are enabled.	H'FFF3 Bit 7	0
	IEN0	Interrupt Enable Register 1 (IRQ0 Interrupt Enable) If IEN0 = 0, $\overline{\text{IRQ0}}$ pin interrupt requests are disabled. If IEN0 = 1, $\overline{\text{IRQ0}}$ pin interrupt requests are enabled.	H'FFF3 Bit 0	1
IRR1	IRRTA	Interrupt Request Register 1 (Timer A Interrupt Request Flag) If IRRTA = 0, Timer A interrupt is not requested. If IRRTA = 1, Timer A interrupt has been requested.	H'FFF6 Bit 7	0
	IRRI0	Interrupt Request Register 1 (IRQ0 Interrupt Request Flag) If IRRI0 = 0, IRQ0 interrupt is not requested. If IRRI0 = 1, IRQ0 interrupt has been requested.	H'FFF6 Bit 0	0

4.4 Description of RAM

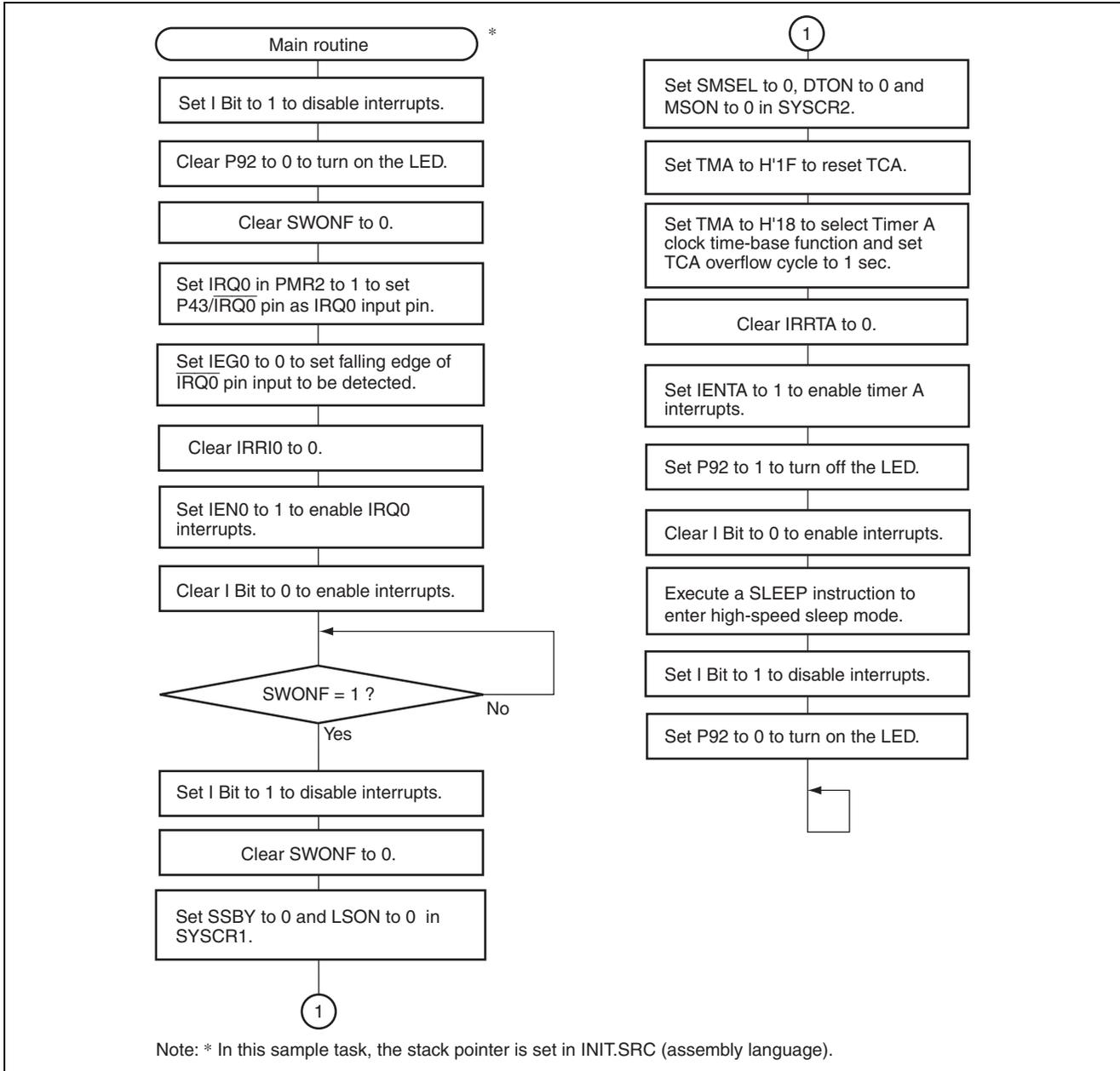
Table 4.3 describes the RAM area used in this sample task.

Table 4.3 Description of RAM

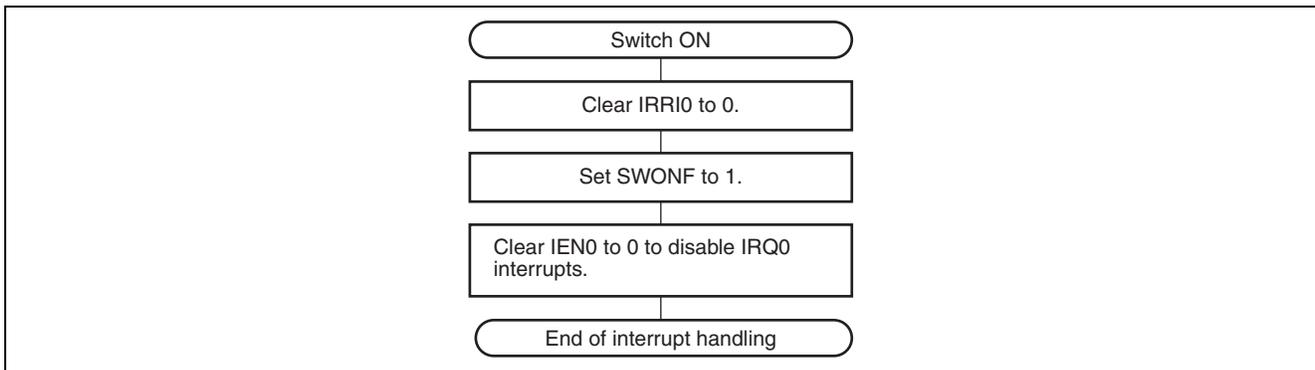
Label	Function	Address	Used in
USRF	SWONF Flag to judge whether the switch input is on or off.	H'FB80 Bit 0	Main routine Switch ON

5. Flowchart

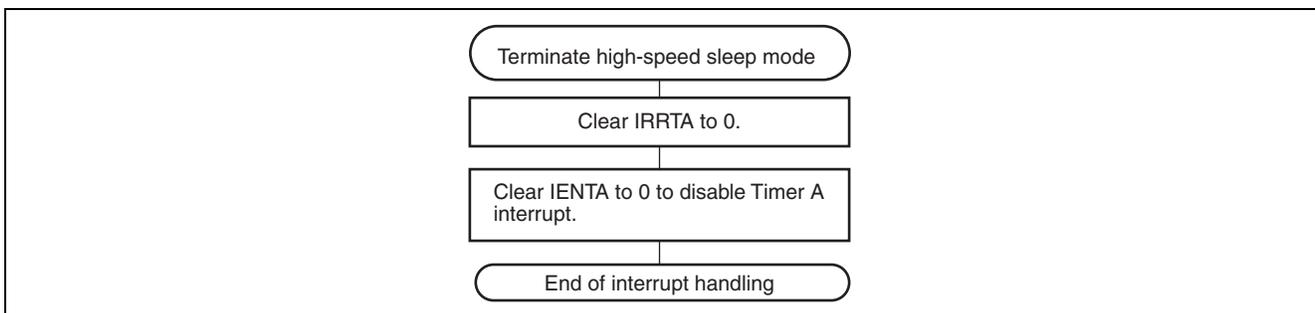
1. Main routine



2. IRQ0 interrupt handling routine



3. Timer A interrupt handling routine



6. Program Listing

INIT.SRC (Program listing)

```

.EXPORT  _INIT
.IMPORT  _main
;
.SECTION P, CODE
_INIT:
MOV.W   #H'FF80, R7
LDC.B   #B'10000000, CCR
JMP     @_main
;
.END

/*****
/*
/* H8/300L Super Low Power Series
/* -H8/38024 Series-
/* Application Note
/*
/* 'Transition to Sleep (High-Speed) Mode'
/*
/* Function
/* : Power-Down Mode
/* Sleep (High-Speed) Mode
/*
/* External Clock : 10MHz
/* Internal Clock : 5MHz
/* Sub Clock      : 32.768kHz
/*
*****/

#include <machine.h>

/*****
/* Symbol Definition
*****/
struct BIT {
    unsigned char  b7:1;    /* bit7 */
    unsigned char  b6:1;    /* bit6 */
    unsigned char  b5:1;    /* bit5 */
    unsigned char  b4:1;    /* bit4 */
    unsigned char  b3:1;    /* bit3 */
    unsigned char  b2:1;    /* bit2 */
    unsigned char  b1:1;    /* bit1 */
    unsigned char  b0:1;    /* bit0 */
};

#define TMA      *(volatile unsigned char *)0xFFB0    /* Timer Mode Register A */
#define TCA      *(volatile unsigned char *)0xFFB1    /* Timer Counter A */
#define PMR2_BIT  (*(struct BIT *)0xFFC9)            /* Port Mode Register 2 */
#define IRQ0     PMR2_BIT.b0                          /* P43/IRQ0 Select */
#define PDR9_BIT  (*(struct BIT *)0xFFDC)            /* Port Data Register 9 */
#define P92      PDR9_BIT.b2                          /* Port Data Register 92 */
#define SYSCR1    *(volatile unsigned char *)0xFFFF0 /* System Control Register 1 */
#define SYSCR1_BIT (*(struct BIT *)0xFFFF0)         /* System Control Register 1 */
#define SSBY     SYSCR1_BIT.b7                        /* Software Standby */
#define STS2     SYSCR1_BIT.b6                        /* Standby Timer Select 2 */

```

```

#define STS1      SYSCR1_BIT.b5      /*Standby Timer Select 1      */
#define STS0      SYSCR1_BIT.b4      /*Standby Timer Select 0      */
#define LSON      SYSCR1_BIT.b3      /*Low Speed On Flag          */
#define MA1       SYSCR1_BIT.b1      /*Active Mode Clock Select 1  */
#define MA0       SYSCR1_BIT.b0      /*Active Mode Clock Select 0  */
#define SYSCR2    *(volatile unsigned char *)0xFFF1 /*System Control Register 2  */
#define SYSCR2_BIT  (*(struct BIT *)0xFFF1) /*System Control Register 2  */
#define NESEL     SYSCR2_BIT.b4      /*Noise Elimination Sampling  */
/*                               Frequency Select */
#define DTON      SYSCR2_BIT.b3      /*Direct Transfer On Flag     */
#define MSON      SYSCR2_BIT.b2      /*Middle Speed On Flag        */
#define SA1       SYSCR2_BIT.b1      /*Subactive Mode Clock Select 1 */
#define SA0       SYSCR2_BIT.b0      /*Subactive Mode Clock Select 0 */
#define IEGR1_BIT  (*(struct BIT *)0xFFF2) /*Interrupt Edge Select Register 1 */
#define IEG0      IEGR1_BIT.b0      /*IRQ0 Edge Select           */
#define IENR1_BIT  (*(struct BIT *)0xFFF3) /*Interrupt Enable Register 1  */
#define IENTA     IENR1_BIT.b7      /*Timer A Interrupt Enable    */
#define IEN0      IENR1_BIT.b0      /*IRQ0 Interrupt Enable       */
#define IENR2_BIT  (*(struct BIT *)0xFFF4) /*Interrupt Enable Register 2  */
#define IENDT     IENR2_BIT.b7      /*Direct Transfer Interrupt Enable */
#define IRR1_BIT  (*(struct BIT *)0xFFF6) /*Interrupt Request Register 1  */
#define IRRTA     IRR1_BIT.b7      /*Timer A Interrupt Request Flag */
#define IRRIO     IRR1_BIT.b0      /*IRQ0 Interrupt Request Flag  */
#define IRR2_BIT  (*(struct BIT *)0xFFF7) /*Interrupt Request Register 2  */
#define IRRDT     IRR2_BIT.b7      /*Direct Transfer Interrupt Request Flag */

#pragma interrupt (irq0int)
#pragma interrupt (taint)
/*****
/* Function define
*****/
extern void INIT ( void );          /*SP Set
void main ( void );
void irq0int ( void );
void taint ( void );

/*****
/* RAM define
*****/
unsigned char USRF;                /*User Flag Erea

#define USRF_BIT  (*(struct BIT *)&USRF)
#define SWONF    USRF_BIT.b0        /*Switch On Flag

```

```

/*****
/*  Vector Address
/*****
#pragma section      V1                      /* Vector Section Set
void (*const VEC_TBL1[])(void) = {
    INIT                      /* 0x0000 Reset Vector
};
#pragma section      V2                      /* Vector Section Set
void (*const VEC_TBL2[])(void) = {
    irq0int                   /* 0x0008 IRQ0 Interrupt Vector
};
#pragma section      V3                      /* Vector Section Set
void (*const VEC_TBL3[])(void) = {
    taint                     /* 0x0016 timer A Interrupt Vector
};

#pragma section                      /*P
/*****
/*  Main Program
/*****
void  main ( void )
{
    set_imask_ccr(1);          /*Interrupt Disable
                                */

    P92 = 0;                  /*Turn On LED
    SWONF = 0;                /*Initialize SWONF

    IRQ0 = 1;                 /*Initialize Input Terminal IRQ0
    IEG0 = 0;                 /*Set Rising Edge Of IEG0 Terminal Input
    IRRIO = 0;                /*Clear IRRIO
    IEN0 = 1;                 /*IEN0 Interrupt Enable

    set_imask_ccr(0);        /*Interrupt Enable
                                */

    while(SWONF != 1){
        ;
    }

    set_imask_ccr(1);        /*Interrupt Disable
                                */

    SWONF = 0;                /*Clear SWONF

    SYSCR1 = 0x07;           /* Set SYSCR1
    SYSCR2 = 0xE0;           /* Set SYSCR2

    TMA = 0x1F;              /*Initialize TCA
    TMA = 0x18;              /*Initialize TCA Overflow Period
    IRRTA = 0;               /*Clear IRRTA
    IENTA = 1;               /*Timer A Interrupt Enable

    P92 = 1;                 /*Turn Off LED

    set_imask_ccr(0);        /*Interrupt Enable
    sleep();                 /*Transition to Sleep Mode

    set_imask_ccr(1);        /*Interrupt Disable
    P92 = 0;                 /*Turn On LED

    while(1){

```

```

;
}
}

/*****
/* IRQ0 Interrupt */
/*****
void irq0int ( void )
{
    IRRIO = 0;          /*Clear IRRIO */
    SWONF = 1;        /*Set SWONF */
    IENO = 0;         /*IENO Interrupt Disable */
}

/*****
/* Timer A Interrupt */
/*****
void taint ( void )
{
    IRRTA = 0;        /*Clear IRRTA */
    IENTA = 0;       /*Timer A Interrupt Disable */
}

```

Link address specifications

Section Name	Address
CV1	H'0000
CV2	H'0008
CV3	H'0016
P	H'0100
B	H'FB80

Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Dec.19.03	—	First edition issued

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